P-Channel 12-V (D-S) MOSFET

CHARACTERISTICS

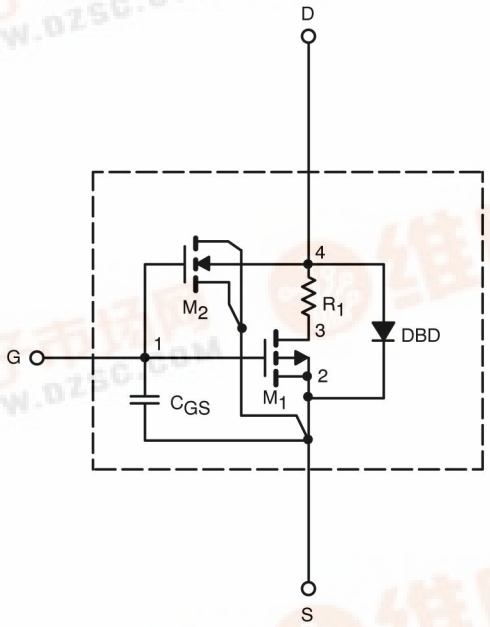
- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the –55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the –55 to 125°C temperature ranges under the pulsed 0 to 5V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

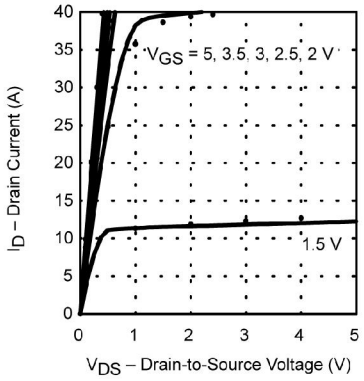
SUBCIRCUIT MODEL SCHEMATIC

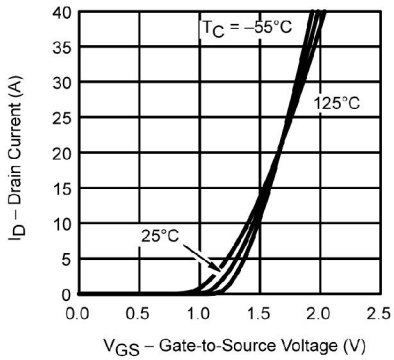


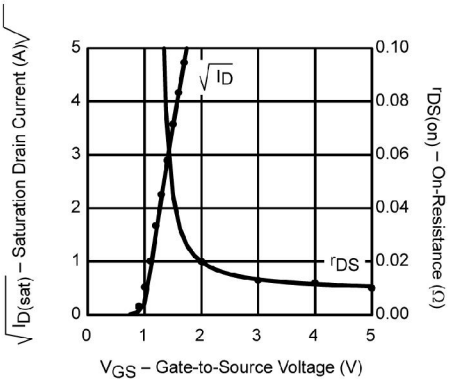
SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	**Symbol**	**Test Conditions**	**Simulated Data**	**Measured Data**	**Unit**
Static					
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = –250 µA	0.78		V
On-State Drain Current[b]	$I_{D(on)}$	V_{DS} = –5 V, V_{GS} = –4.5 V	298		A
Drain-Source On-State Resistance[b]	$r_{DS(on)}$	V_{GS} = –4.5 V, I_D = –8.6 A	0.011	0.011	Ω
		V_{GS} = –2.5 V, I_D = –7.6 A	0.0143	0.0145	
		V_{GS} = – 1.8 V, I_D = –6.7 A	0.0201	0.0185	
Forward Transconductance[b]	g_{fs}	V_{DS} = –15 V, I_D = – 8.6 A	32	35	S
Diode Forward Voltage[b]	V_{SD}	I_S = –1.5 A, V_{GS} = 0 V	–0.79	–0.62	V
Dynamic[a]					
Total Gate Charge	Q_g	V_{DS} = –10 V, V_{GS} = –4.5 V, I_D = –8.6 A	36	42	nC
Gate-Source Charge	Q_{gs}		4.6	4.6	
Gate-Drain Charge	Q_{gd}		12.7	12.7	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = –10 V, R_L = 10 Ω I_D ≅ –1 A, V_{GEN} = –4.5 V, R_G = 6 Ω	67	50	ns
Rise Time	t_r		67	105	
Turn-Off Delay Time	$t_{d(off)}$		190	185	
Fall Time	t_f		61	135	

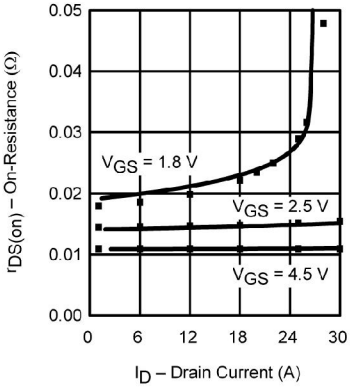
Notes
a. Guaranteed by design, not subject to production testing.
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2%.

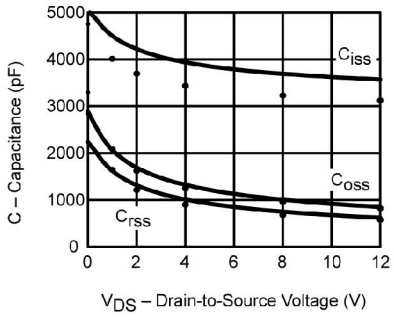
COMPARISON OF MODEL WITH MEASURED DATA (T_J=25°C UNLESS OTHERWISE NOTED)

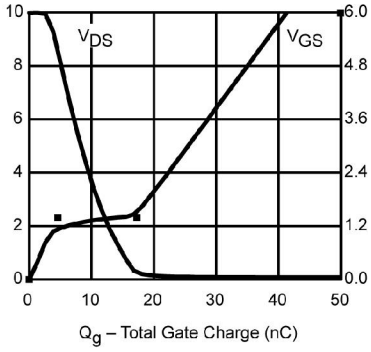












Note: Dots and squares represent measured data.